## onsemi

### MOSFET – Power, Single, N-Channel, DFN5/DFNW5 40 V, 1.3 mΩ, 235 A

### NVMFS5C426N

#### Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS5C426NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### Parameter Symbol Value Unit v Drain-to-Source Voltage VDSS 40 Gate-to-Source Voltage V<sub>GS</sub> v ±20 Continuous Drain $T_{\rm C} = 25^{\circ}{\rm C}$ $I_{D}$ 235 A Current R<sub>0JC</sub> $T_{\rm C} = 100^{\circ}{\rm C}$ 166 (Notes 1, 3) Steady State $T_C = 25^{\circ}C$ Power Dissipation $P_D$ 128 W $R_{\theta,IC}$ (Note 1) $T_{\rm C} = 100^{\circ}{\rm C}$ 64 Continuous Drain $T_A = 25^{\circ}C$ 41 А $I_D$ Current R<sub>0JA</sub> $T_A = 100^{\circ}C$ 29 (Notes 1, 2, 3) Steady State Power Dissipation w $T_A = 25^{\circ}C$ $P_D$ 3.8 R<sub>0JA</sub> (Notes 1 & 2) $T_A = 100^{\circ}C$ 1.9 Pulsed Drain Current $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ 900 A IDM °C Operating Junction and Storage Temperature T<sub>J</sub>, T<sub>stg</sub> -55 to + 175 Source Current (Body Diode) 122 А Is E<sub>AS</sub> Single Pulse Drain-to-Source Avalanche 739 m.J Energy (I<sub>L(pk)</sub> = 19 A) Lead Temperature for Soldering Purposes $T_{L}$ 260 °C (1/8" from case for 10 s)

### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

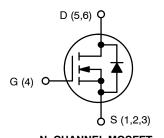
| Parameter                                   | Symbol          | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Case - Steady State             | $R_{\theta JC}$ | 1.2   | °C/W |
| Junction-to-Ambient - Steady State (Note 2) | $R_{\theta JA}$ | 39    |      |

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

| V <sub>(BR)DSS</sub> | R <sub>DS(ON)</sub> MAX | I <sub>D</sub> MAX |
|----------------------|-------------------------|--------------------|
| 40 V                 | 1.3 mΩ @ 10 V           | 235 A              |



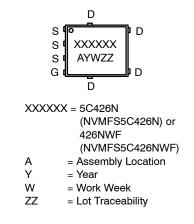
N-CHANNEL MOSFET



DFN5 (SO-8FL) CASE 488AA

DFNW5 (FULL-CUT SO8FL WF) CASE 507BA

#### MARKING DIAGRAM



#### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

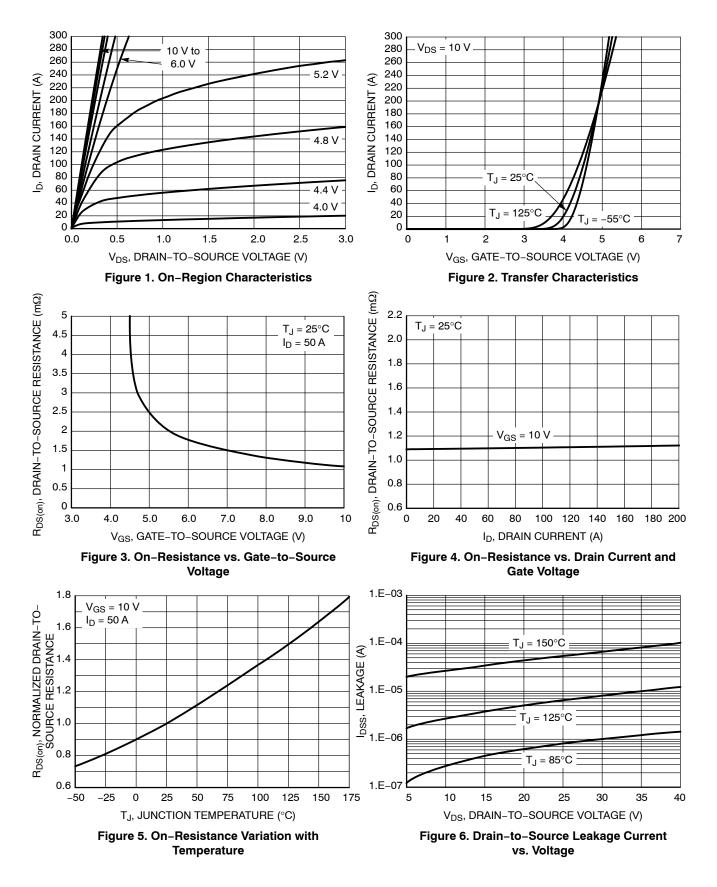
#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

| Parameter  | Symbol                                   | Test Condition   |                             | Min  | Тур  | Max | Unit  |
|--|--|--|-----------------------------|------|------|-----|-------|
| OFF CHARACTERISTICS  | -  |  |                             |      |      |     |       |
| Drain-to-Source Breakdown Voltage                            | V <sub>(BR)DSS</sub>                     | $V_{GS} = 0 V, I_D =$  | = 250 μA                    | 40   |      |     | V     |
| Drain-to-Source Breakdown Voltage<br>Temperature Coefficient | V <sub>(BR)DSS</sub> /<br>T <sub>J</sub> |  |                             |      | 9.6  |     | mV/°C |
| Zero Gate Voltage Drain Current                              | I <sub>DSS</sub>                         | $V_{GS} = 0 V,$  | $T_J = 25^{\circ}C$         |      |      | 10  |       |
|  |  | $V_{DS} = 40 V$  | T <sub>J</sub> = 125°C      |      |      | 100 | μΑ    |
| Gate-to-Source Leakage Current                               | I <sub>GSS</sub>                         | $V_{DS}$ = 0 V, $V_{G}$  | <sub>S</sub> = 20 V         |      |      | 100 | nA    |
| ON CHARACTERISTICS (Note 4)                                  |  |  |                             |      |      |     |       |
| Gate Threshold Voltage                                       | V <sub>GS(TH)</sub>                      | $V_{GS} = V_{DS}, I_D$   | = 170 μA                    | 2.5  |      | 3.5 | V     |
| Threshold Temperature Coefficient                            | V <sub>GS(TH)</sub> /T <sub>J</sub>      |  |                             |      | -8.6 |     | mV/°C |
| Drain-to-Source On Resistance                                | R <sub>DS(on)</sub>                      | V <sub>GS</sub> = 10 V   | I <sub>D</sub> = 50 A       |      | 1.1  | 1.3 | mΩ    |
| Forward Transconductance                                     | 9 <sub>FS</sub>                          | V <sub>DS</sub> =15 V, I <sub>[</sub>  | <sub>D</sub> = 50 A         |      | 145  |     | S     |
| CHARGES, CAPACITANCES & GATE RE                              | SISTANCE                                 |  |                             |      |      |     |       |
| Input Capacitance  | C <sub>ISS</sub>                         |  |                             | 4300 |      |     |       |
| Output Capacitance   | C <sub>OSS</sub>                         |  |                             |      | 2100 |     | pF    |
| Reverse Transfer Capacitance                                 | C <sub>RSS</sub>                         |  |                             |      | 59   |     |       |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                      | V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 2  | 20 V; I <sub>D</sub> = 50 A |      | 65   |     |       |
| Threshold Gate Charge  | Q <sub>G(TH)</sub>                       |  |                             |      | 13   |     |       |
| Gate-to-Source Charge  | Q <sub>GS</sub>                          | V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 20 V; I <sub>D</sub> = 50 A              |                             |      | 20   |     | nC    |
| Gate-to-Drain Charge   | Q <sub>GD</sub>                          |  |                             |      | 12   |     |       |
| Plateau Voltage  | V <sub>GP</sub>                          |  |                             |      | 4.7  |     | V     |
| SWITCHING CHARACTERISTICS (Note 5                            | 5)                                       |  |                             |      |      |     |       |
| Turn-On Delay Time   | t <sub>d(ON)</sub>                       | $V_{GS}$ = 10 V, $V_{DS}$ = 20 V,<br>I <sub>D</sub> = 50 A, R <sub>G</sub> = 2.5 Ω |                             |      | 15   |     |       |
| Rise Time  | tr                                       |  |                             |      | 47   |     | ns    |
| Turn-Off Delay Time  | t <sub>d(OFF)</sub>                      |  |                             |      | 36   |     |       |
| Fall Time  | t <sub>f</sub>                           |  |                             |      | 9.0  |     |       |
| DRAIN-SOURCE DIODE CHARACTERIS                               | TICS                                     |  |                             |      |      |     |       |
| Forward Diode Voltage  | V <sub>SD</sub>                          | V <sub>GS</sub> = 0 V,<br>I <sub>S</sub> = 50 A                                    | $T_J = 25^{\circ}C$         |      | 0.82 | 1.2 | v     |
|  |  |  | T <sub>J</sub> = 125°C      |      | 0.68 |     |       |
| Reverse Recovery Time  | t <sub>RR</sub>                          | V <sub>GS</sub> = 0 V, dIS/dt = 100 A/μs,<br>I <sub>S</sub> = 50 A                 |                             |      | 63   |     | ns    |
| Charge Time  | ta                                       |  |                             |      | 34   |     |       |
| Discharge Time   | t <sub>b</sub>                           |  |                             |      | 29   |     |       |
| Reverse Recovery Charge                                      | Q <sub>RR</sub>                          |  |                             |      | 92   |     | nC    |

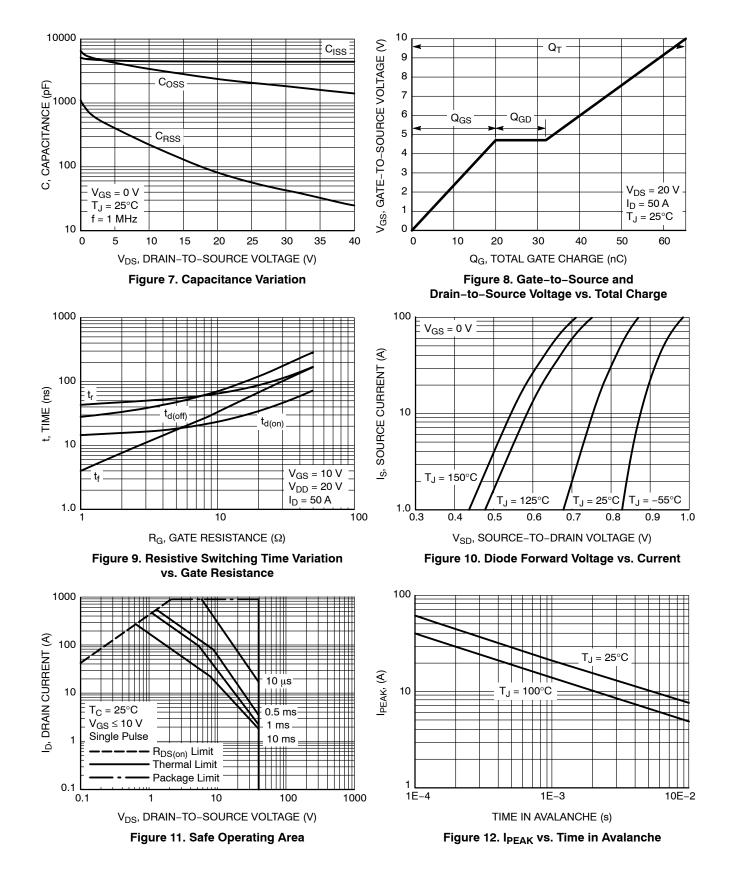
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq 300 \ \mu$ s, duty cycle  $\leq 2\%$ .

5. Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



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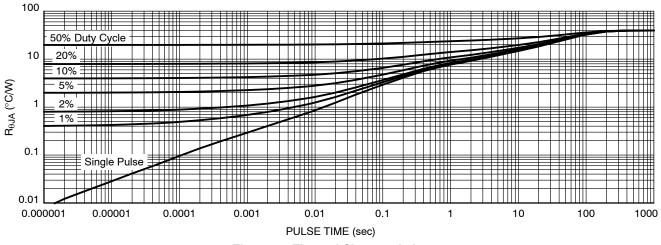


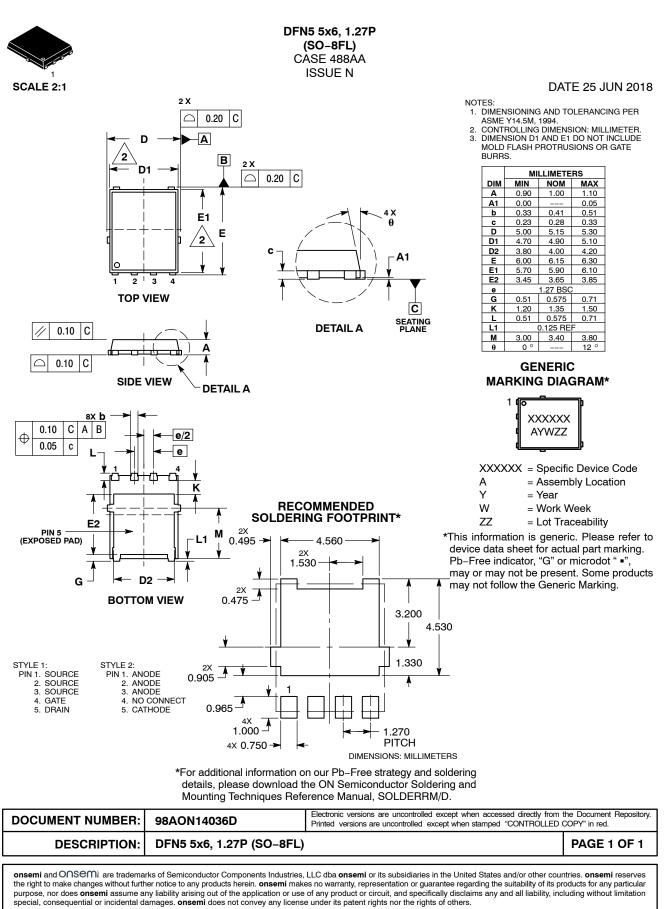
Figure 13. Thermal Characteristics

| Device              | Marking | Package                             | Shipping <sup>†</sup> |
|---------------------|---------|-------------------------------------|-----------------------|
| NVMFS5C426NT1G      | 5C426N  | DFN5<br>(Pb-Free)                   | 1500 / Tape & Reel    |
| NVMFS5C426NWFT1G    | 426NWF  | DFNW5<br>(Pb-Free, Wettable Flanks) | 1500 / Tape & Reel    |
| NVMFS5C426NT3G      | 5C426N  | DFN5<br>(Pb-Free)                   | 5000 / Tape & Reel    |
| NVMFS5C426NWFT3G    | 426NWF  | DFNW5<br>(Pb-Free, Wettable Flanks) | 5000 / Tape & Reel    |
| NVMFS5C426NAFT1G    | 5C426N  | DFN5<br>(Pb-Free)                   | 1500 / Tape & Reel    |
| NVMFS5C426NAFT1G-YE | 5C426N  | DFN5<br>(Pb-Free)                   | 1500 / Tape & Reel    |
| NVMFS5C426NWFAFT1G  | 426NWF  | DFNW5<br>(Pb-Free, Wettable Flanks) | 1500 / Tape & Reel    |

#### **DEVICE ORDERING INFORMATION**

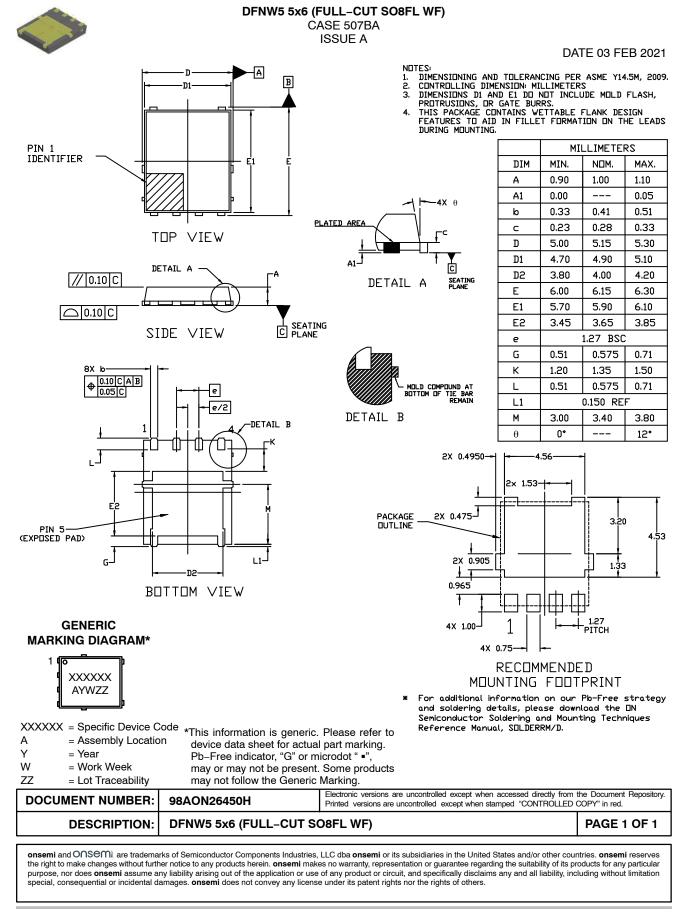
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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